

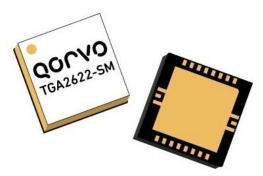
9-10 GHz 35 Watt GaN Power Amplifier

Product Description

Qorvo's TGA2622-SM is a packaged, high power X-Band amplifier fabricated on Qorvo's production 0.25um GaN on SiC process. Operating from 9-10GHz, the TGA2622-SM typically generates 35W of saturated output power with a power-added efficiency greater than 42% and 27.5dB of large signal gain.

The TGA2622-SM is packaged in a 7x7mm air-cavity, laminate based QFN. Both RF ports are internally DC blocked and matched to 50 ohms enabling simple system integration. Ideally suited for pulsed applications, the TGA2622-SM offers superior power, PAE and gain performance that can save costs on existing platforms while enabling the development of future systems.

Lead-free and RoHS compliant.



QFN 7x7 mm 22L

Product Features

Frequency Range: 9 – 10 GHz
 P_{SAT}: 45.5 dBm @ PIN = 18 dBm

• PAE: 42% @ PIN = 18 dBm

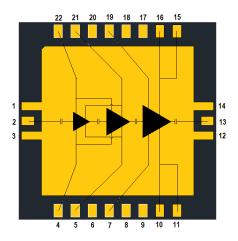
• Power Gain: 27.5 dB @ PIN = 18 dBm

 Bias: V_D = 28 V, I_{DQ} = 290 mA (Pulsed V_D: PW = 100 us and DC = 10 %)

• Package Dimensions: 7 x 7 x 1.75 mm

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

Functional Block Diagram



Applications

Weather and Marine Radar

Ordering Information

Part	Description
TGA2622-SM	9 – 10 GHz 35 W GaN Power Amplifier
TGA2622-SM EVB	Evaluation Board



9-10 GHz 35 Watt GaN Power Amplifier

Absolute Maximum Ratings

Parameter	Value		
Drain Voltage (V _D)	40 V		
Gate Voltage Range (V _G)	-8 to 0V		
Drain Current (I _D)	4.3 A		
Gate Current (I _G)	See page 11		
Power Dissipation (PDISS), 85°C, CW	88 W		
Input Power (P_{IN}), CW, 50Ω , $V_D = 28V$, $85^{\circ}C$	24 dBm		
Input Power (P _{IN}), CW, VSWR 3:1, VD = 28V, 85°C	24 dBm		
Mounting Temperature (30 seconds)	260 °C		
Storage Temperature	-55 to 150 °C		

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Operating Conditions

Parameter	Value
Drain Voltage (V _D)	28 V
Drain Current (quiescent, IDQ)	290 mA
Gate Voltage Range (V _G)	−2.8 to −2.0 V
Operating Temperature Range	−40 to 85 °C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

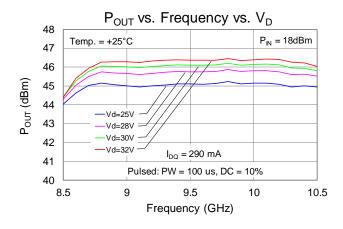
Electrical Specifications

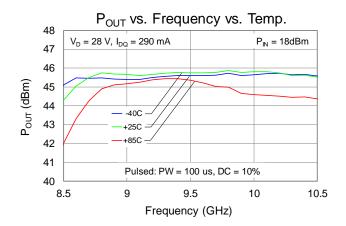
Test conditions unless otherwise noted: $25 \,^{\circ}$ C, $V_D = 28 \, \text{V}$, $I_{DQ} = 290 \, \text{mA}$, Pulsed V_D : PW = 100 us, DC = 10%

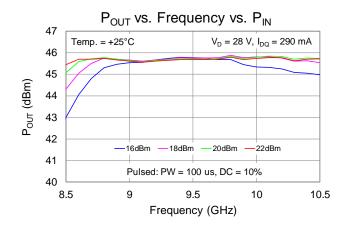
Parameter	Min	Тур	Max	Units		
Operational Frequency Range		9	_	10	GHz	
	Frequency = 9 GHz	45	45.7	_	dBm	
Output Power @ P _{IN} = 18 dBm	Frequency = 9.5 GHz	45	45.8	_	dBm	
	Frequency = 10 GHz	45	45.8	_	dBm	
Davier Added Efficiency	Frequency = 9 GHz	40	46.4	_		
Power Added Efficiency @ P _{IN} = 18 dBm	Frequency = 9.5 GHz	40	46.4	_	%	
W PIN = TOUBITI	Frequency = 10 GHz	35	43	_		
	Frequency = 9 GHz	_	31.5	_		
Small Signal Gain	Frequency = 9.5 GHz	_	32.7	_	dB	
	Frequency = 10 GHz	_	31.4	_		
Input Return Loss	Frequency = 9 GHz	_	14.7	_		
	Frequency = 9.5 GHz	_	15	_	dB	
	Frequency = 10 GHz	_	11	_		
Output Return Loss	Frequency = 9 GHz	_	10.6	_		
	Frequency = 9.5 GHz	_	9.3	_	dB	
	Frequency = 10 GHz	_	12	_		
Output Power Temperature Coefficient From 25°C to 85°C (Pin = 18dBm)		_	-0.02	_	dBm/°C	

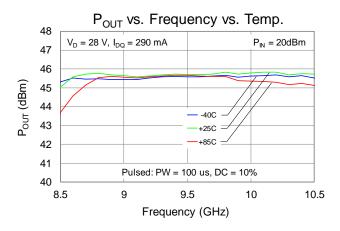


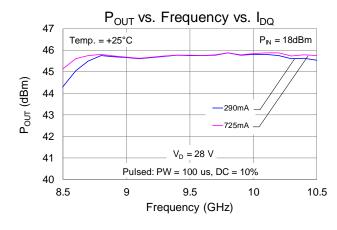
9-10 GHz 35 Watt GaN Power Amplifier

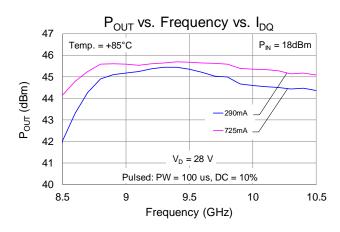






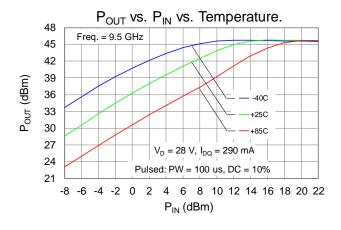


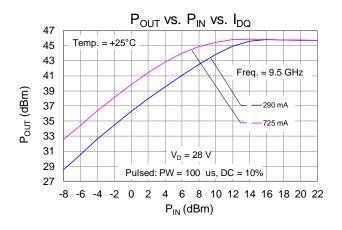


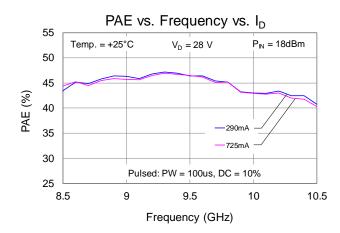


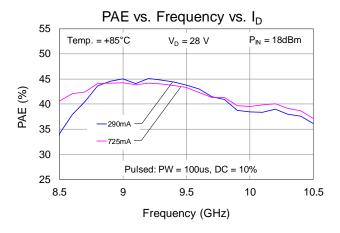


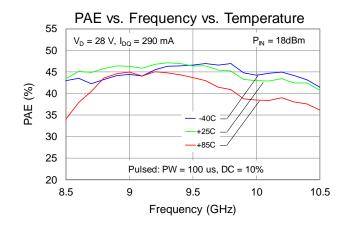
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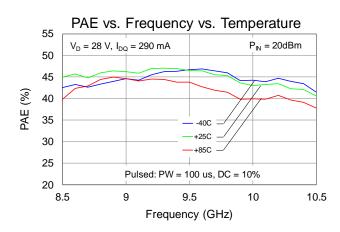






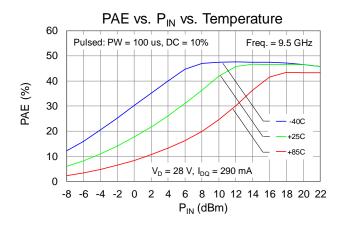


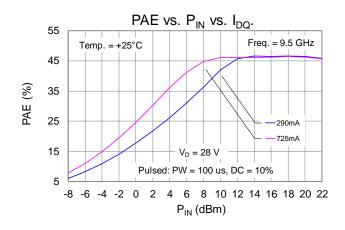


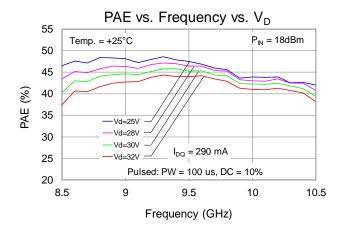


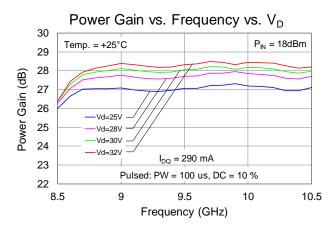


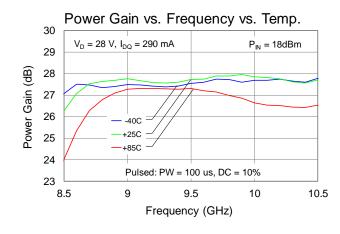
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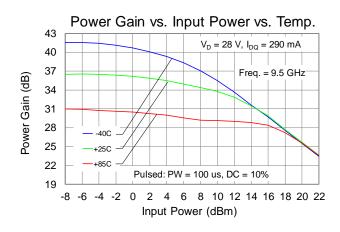






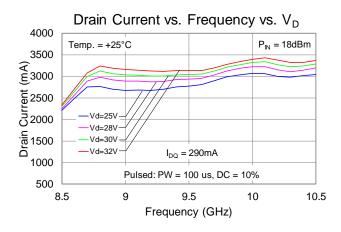


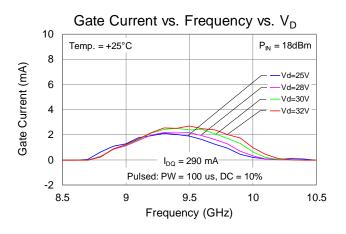


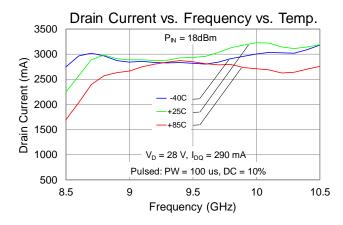


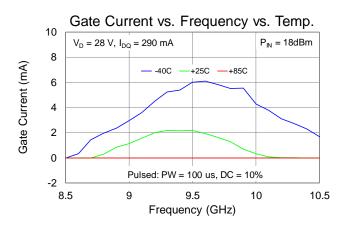


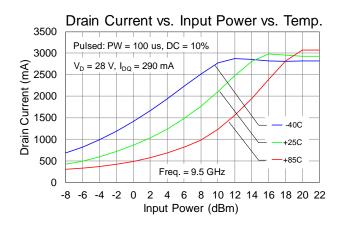
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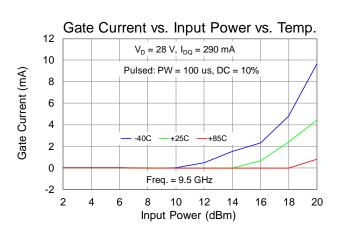








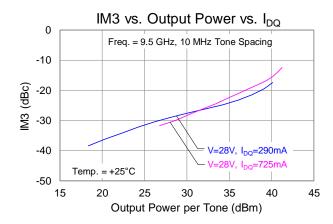


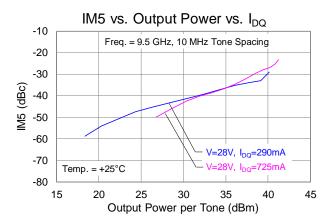


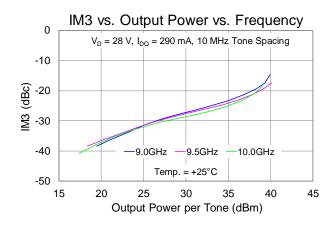


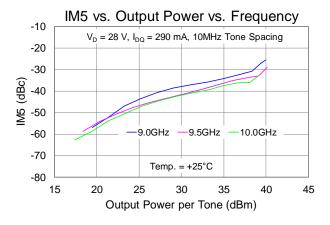
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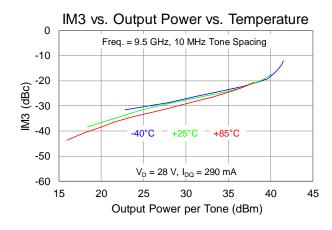
Performance Plots - Linearity (CW)

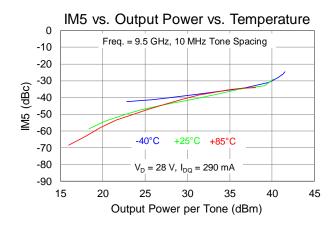








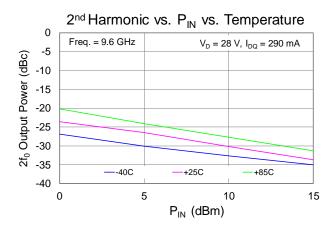


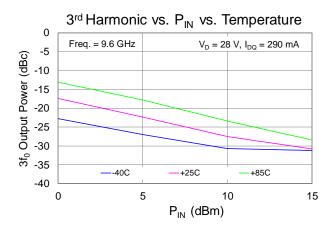


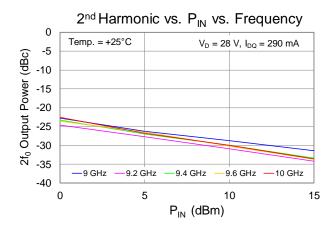


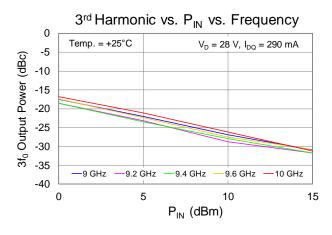
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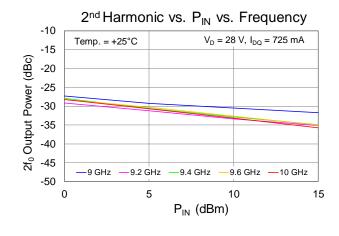
Performance Plots – Linearity (CW)

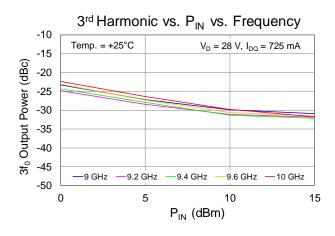








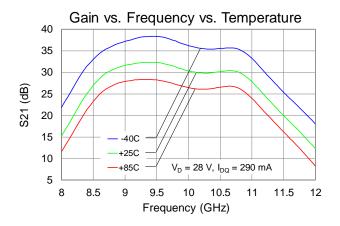


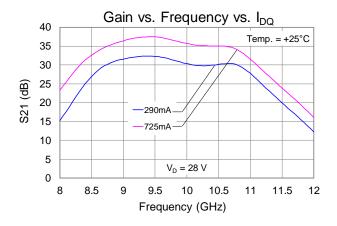


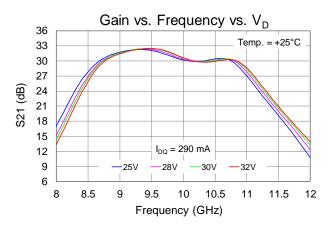


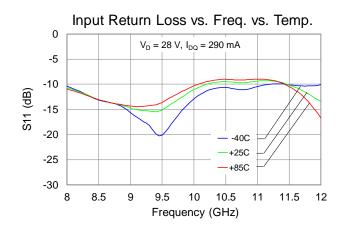
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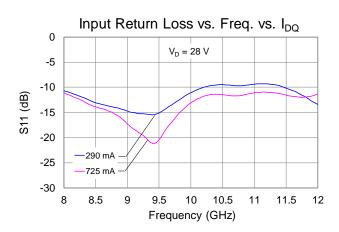
Performance Plots - Small Signal (CW)







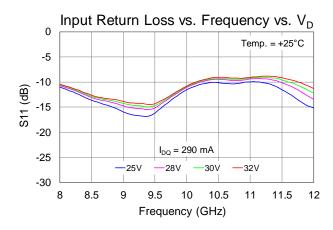


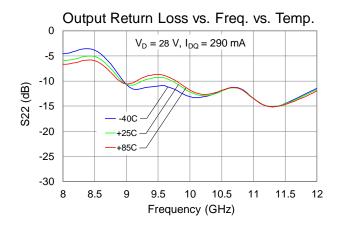


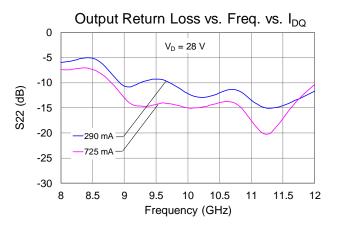


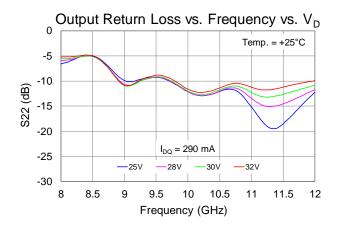
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Performance Plots - Small Signal (CW)









9-10 GHz 35 Watt GaN Power Amplifier

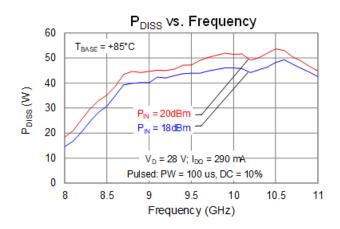
Thermal and Reliability Information

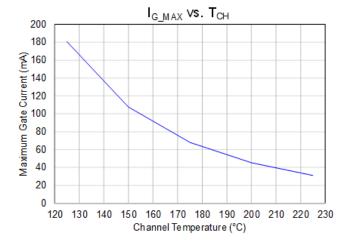
Parameter	Test Conditions	Value	Units
Thermal Resistance (θ _{JC}) ⁽¹⁾	V _D = 28 V, I _{DQ} = 290 mA, (Pulsed V _D : PW = 100	0.51	°C/W
Channel Temperature (T _{CH}) (No RF drive) ²	us, DC = 10 %), T _{base} = 85 °C; P _{DISS} = 8.12 W	89.1	°C
Thermal Resistance (θ _{JC}) ⁽¹⁾	T _{base} = 85 °C, V _D = 28 V, I _{DQ} = 290 mA, (Pulsed V _D : PW = 100 us, DC = 10 %), I _{D Drive} = 3.1 A,	0.83	°C/W
Channel Temperature (T _{CH}) (With RF drive) ²	PIN = 20 dBm, POUT = 45.4 dBm, PDISS = 52 W	128.2	°C

Notes

- 1. Thermal Resistance referenced to the back of the package.
- IR scan equivalent. Refer to the following document: <u>GaN Device Channel Temperature, Thermal Resistance, and Reliability</u> Estimates

Power Dissipation and Maximum Gate Current

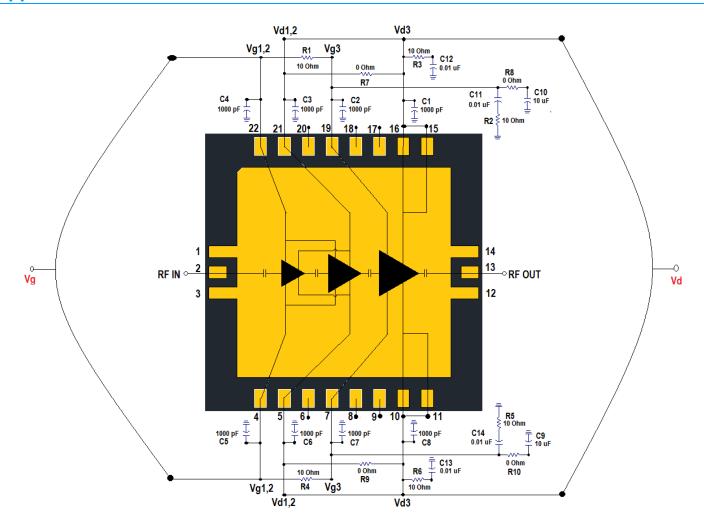






9-10 GHz 35 Watt GaN Power Amplifier

Applications Circuit



Notes:

- 1. $V_{G:}$ must be biased from both sides $V_{G1,2}$ & V_{G3} can be tied together.
- 2. V_D : must be biased from both sides $V_{D1,2}$ & V_{D3} can be tied together.

Bias Up Procedure

- 1. Set ID limit to 3.5 A, IG limit to 25 mA
- 2. Set V_G to -5.0 V (for pinch-off)
- 3. Set V_D +28 V; Ensure I_{DQ} is approx. 0 mA
- 4. Adjust V_G more positive until I_{DQ} = 290mA ($V_G \sim -2.3 \text{ V Typical}$)
- 5. Apply RF signal

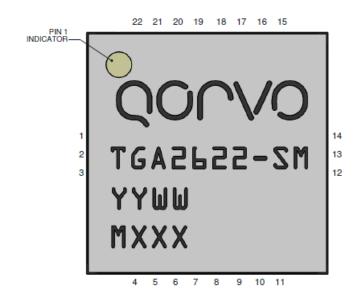
Bias Down Procedure

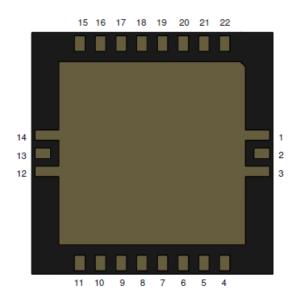
- 1. Turn off RF supply
- 2. Reduce V_G to -5.0V. Ensure $I_{DQ} \sim 0 \text{mA}$
- 3. Set V_D to 0 V
- 4. Turn off V_D supply
- 5. Turn off V_G supply



9-10 GHz 35 Watt GaN Power Amplifier

Pin Layout





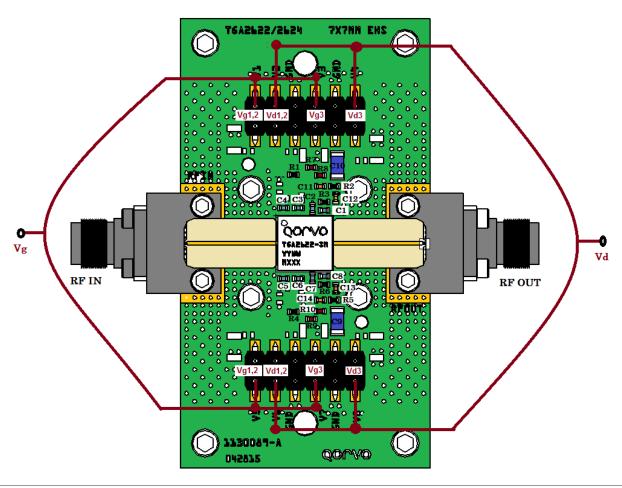
Pin Description

Pin No.	Symbol	Description
1, 3, 12, 14	GND	Must be grounded on the PCB
2	RF _{IN}	Input; matched to 50 Ω; DC blocked
4, 22	V _{G1,2}	Gate Voltages 1,2; Bias network is required; must be biased from both sides; see recommended Application Information on page 12.
5, 21	V _{D1,2}	Drain voltages 1,2; Bias network is required; must be biased from both sides; see recommended Application Information on page 12.
6, 8, 9, 17, 18, 20	N/C	No internal connection
7, 19	V _{G3}	Gate Voltage 3; Bias network is required; must be biased from both sides; see recommended Application Information on page 12.
10, 11, 15, 16	V _{D3}	Drain voltage 3; Bias network is required; must be biased from both sides; see recommended Application Information on page 12.
13	RFout	Output; matched to 50 Ω; DC blocked



9-10 GHz 35 Watt GaN Power Amplifier

Evaluation Board Layout



Notes: Both Top and Bottom VD and VG must be biased.

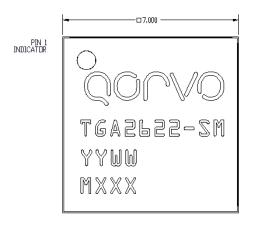
Bill of Materials

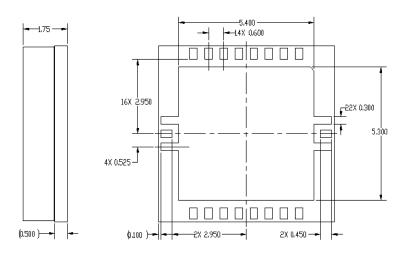
Reference Des.	Value	Description	Manuf.	Part Number
C1 – C8	1000 pF	Cap, 0402, 100 V, 10%, X7R	Various	
C9-C10	10 μF	Cap, 1206, 50 V, 20%, X5R	Various	
C11 – C14	0.01 µF	Cap, 0402, 50 V, 10%, X7R	Various	
R1-R6	10 ohms	Res, 0402, 50 V, 5%, SMD	Various	
R7-R10	0 ohms	Res, 0402, jumpers required for the above EVB	Various	



9-10 GHz 35 Watt GaN Power Amplifier

Mechanical Information





Units: Millimeters (mm)

Tolerances: unless specified

 $x.xx = \pm 0.25$; $x.xxx = \pm 0.100$

Materials:

Base: Laminate Substrate

Lid: Laminate

All metalized features are gold plated

Part is epoxy sealed

Marking:

TGA2622-SM: Part number

YY: Part Assembly year WW: Part Assembly week

MXXX: Batch ID



9-10 GHz 35 Watt GaN Power Amplifier

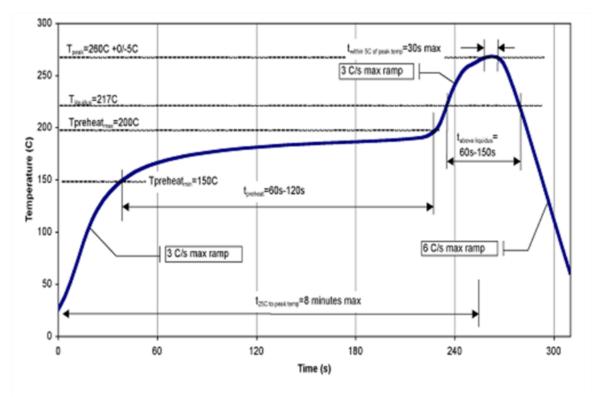
Assembly Notes

Compatible with lead-free soldering processes with 260°C peak reflow temperature.

This package is air-cavity and non-hermetic, and therefore cannot be subjected to aqueous washing. The use of no-clean solder to avoid washing after soldering is highly recommended.

Contact plating: Ni-Au.

Solder rework not recommended.



Recommended Soldering Temperature Profile



9-10 GHz 35 Watt GaN Power Amplifier

Handling Precautions

Parameter	Rating	Standard	Courtism
ESD – Human Body Model (HBM)	Class 1B	ANSI/ESD/JEDEC JS-001	Caution! ESD-Sensitive Device
MSL-Moisture Sensitivity Level	Level 3	IPC/JEDEC J-STD-020	LOD OCHSILIVE DEVICE

RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Tel: 1-844-890-8163
Web: <u>www.qorvo.com</u>

Email: info-sales@gorvo.com

For technical questions and application information: Email: info-products@gorvo.com

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